## High Voltage, Low Noise, Low Distortion, Unity Gain Stable, High Speed Op Amp

## ADA4898-1

## FEATURES

Ultralow noise
$0.9 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$
$2.4 \mathrm{pA} / \sqrt{\mathrm{Hz}}$
$1.2 \mathrm{nV} / \mathrm{V} \mathrm{Hz}$ @ 10 Hz
Ultralow distortion: -93 dBc at 500 kHz
Wide supply voltage range: $\pm 5 \mathrm{~V}$ to $\pm 16 \mathrm{~V}$
High speed
-3 dB bandwidth: $65 \mathrm{MHz}(\mathrm{G}=+1)$
Slew rate: $55 \mathrm{~V} / \mu \mathrm{s}$
Unity gain stable
Low input offset voltage: $\mathbf{1 5 0} \boldsymbol{\mu V}$ maximum
Low input offset voltage drift: $1 \mu \mathrm{~V} /{ }^{\circ} \mathrm{C}$
Low input bias current: - $0.1 \mu \mathrm{~A}$
Low input bias current drift: $2 \mathrm{nA} /{ }^{\circ} \mathrm{C}$
Supply current: 8 mA
Power-down feature

## APPLICATIONS

## Instrumentation

Active filters
DAC buffers
SAR ADC drivers
Optoelectronics

## GENERAL DESCRIPTION

The ADA4898-1 is an ultralow noise and distortion, unity gain stable, voltage feedback op amp that is ideal for use in 16-bit and 18 -bit systems with power supplies from $\pm 5 \mathrm{~V}$ to $\pm 16 \mathrm{~V}$. The ADA4898-1 features a linear, low noise input stage and internal compensation that achieves high slew rates and low noise.

With the wide supply voltage range, low offset voltage, and wide bandwidth, the ADA4898-1 is designed to work in the most demanding applications. The ADA4898-1 also features an input bias current cancellation mode that reduces input bias current by a factor of 60 .

The ADA4898-1 is available in an 8-lead SOIC package that features an exposed metal paddle on its underside that improves heat transfer to the ground plane. This is a significant improvement over traditional plastic packages. The ADA4898-1 is rated to work over the extended automotive temperature range of $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$.

## ADA4898-1

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## REVISION HISTORY

5/08-Revision 0: Initial Release

## SPECIFICATIONS WITH $\pm 15$ V SUPPLY

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{G}=+1, \mathrm{R}_{\mathrm{F}}=0 \Omega, \mathrm{R}_{\mathrm{G}}$ open, $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to GND (for $\mathrm{G}>1, \mathrm{R}_{\mathrm{F}}=100 \Omega$ ), unless otherwise noted.
Table 1.

| Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness <br> Slew Rate <br> Settling Time to 0.1\% | $\begin{aligned} & \text { Vout }=100 \mathrm{mV} \text { p-p } \\ & \mathrm{V}_{\text {out }}=2 \mathrm{~V} \text { p-p } \\ & \mathrm{G}=+2, \mathrm{~V}_{\text {out }}=2 \mathrm{~V} \text { p-p } \\ & \mathrm{V}_{\text {out }}=5 \mathrm{~V} \text { step } \\ & \mathrm{V}_{\text {out }}=5 \mathrm{~V} \text { step } \end{aligned}$ |  | $\begin{aligned} & 65 \\ & 14 \\ & 3.3 \\ & 55 \\ & 85 \end{aligned}$ |  | MHz <br> MHz <br> MHz <br> $\mathrm{V} / \mu \mathrm{s}$ <br> ns |
| NOISE/DISTORTION PERFORMANCE <br> Harmonic Distortion SFDR <br> Input Voltage Noise <br> Input Current Noise | $\begin{aligned} & f=100 \mathrm{kHz}, V_{\text {out }}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}=500 \mathrm{kHz}, \mathrm{~V}_{\text {out }}=2 \mathrm{~V} p-\mathrm{p} \\ & \mathrm{f}=1 \mathrm{MHz}, V_{\text {out }}=2 \mathrm{~V} \mathrm{p}-\mathrm{p} \\ & \mathrm{f}=100 \mathrm{kHz} \\ & \mathrm{f}=100 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & -116 \\ & -93 \\ & -79 \\ & 0.9 \\ & 2.4 \end{aligned}$ |  | dBc <br> dBc <br> dBc <br> $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ <br> $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |
| DC PERFORMANCE <br> Input Offset Voltage <br> Input Offset Voltage Drift <br> Input Bias Current <br> Input Bias Offset Current <br> Input Bias Current Drift <br> Open-Loop Gain | Vout $= \pm 5 \mathrm{~V}$ | $99$ | $\begin{aligned} & 20 \\ & 1 \\ & -0.1 \\ & 0.03 \\ & 2 \\ & 103 \end{aligned}$ | $\begin{aligned} & 110 \\ & -0.4 \\ & 0.3 \end{aligned}$ | $\mu \mathrm{V}$ <br> $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ <br> $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> $n A /{ }^{\circ} \mathrm{C}$ <br> dB |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input Capacitance <br> Input Common-Mode Voltage Range Common-Mode Rejection Ratio | Differential mode <br> Common mode <br> Differential mode <br> Common mode $V_{C M}= \pm 2 \mathrm{~V}$ | -103 | $\begin{aligned} & 5 \\ & 30 \\ & 0.8 \\ & 2.2 \\ & \pm 11 \\ & -126 \end{aligned}$ |  | $\mathrm{k} \Omega$ <br> $\mathrm{M} \Omega$ <br> pF <br> pF <br> V <br> dB |
| $\overline{\overline{P D}}$ (Power Down) PIN $\overline{\mathrm{PD}}$ Input Voltages <br> Input Leakage Current | Chip powered down <br> Chip enabled $\begin{aligned} & \overline{P D}=+V_{s} \\ & \overline{P D}=-V_{s} \end{aligned}$ |  | $\begin{aligned} & \leq-14 \\ & \geq-13 \\ & -0.1 \\ & -0.2 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing <br> Short-Circuit Current Off Isolation | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \\ & \mathrm{R}_{\mathrm{L}}=\mathrm{None} \end{aligned}$ <br> Sinking/sourcing $\mathrm{f}=1 \mathrm{MHz}, \overline{\mathrm{PD}}=-\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & -11.4 \text { to }+12.1 \\ & \pm 12.76 \end{aligned}$ | $\begin{aligned} & -11.7 \text { to }+12.2 \\ & \pm 12.82 \\ & 150 \\ & 80 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current <br> Positive Power Supply Rejection Ratio Negative Power Supply Rejection Ratio | $\begin{aligned} & \overline{\mathrm{PD}}=+\mathrm{V}_{\mathrm{s}} \\ & \overline{\mathrm{PD}}=-\mathrm{V}_{\mathrm{s}} \\ & +\mathrm{V}_{\mathrm{s}}=15 \mathrm{~V} \text { to } 17 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-15 \mathrm{~V} \\ & +\mathrm{V}_{\mathrm{s}}=15 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-15 \mathrm{~V} \text { to }-17 \mathrm{~V} \end{aligned}$ | $\pm 4.5$ $\begin{aligned} & -98 \\ & -100 \end{aligned}$ | $\begin{aligned} & 8.1 \\ & 0.1 \\ & -107 \\ & -114 \end{aligned}$ | $\pm 16.5$ | V <br> mA <br> mA <br> dB <br> dB |

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## SPECIFICATIONS WITH $\pm 5$ V SUPPLY

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{G}=+1, \mathrm{R}_{\mathrm{F}}=0 \Omega, \mathrm{R}_{\mathrm{G}}$ open, $\mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega$ to GND (for $\mathrm{G}>1, \mathrm{R}_{\mathrm{F}}=100 \Omega$ ), unless otherwise noted.
Table 2.

| Parameter | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| DYNAMIC PERFORMANCE <br> -3 dB Bandwidth <br> Bandwidth for 0.1 dB Flatness <br> Slew Rate <br> Settling Time to 0.1\% | $\begin{aligned} & \text { Vout }=100 \mathrm{mV} \text { p-p } \\ & \mathrm{V}_{\text {out }}=2 \mathrm{Vp} \text { p-p } \\ & \mathrm{G}=+2, \mathrm{~V}_{\text {out }}=2 \mathrm{~V} \text { p-p } \\ & \mathrm{V}_{\text {out }}=2 \mathrm{~V} \text { step } \\ & \mathrm{V}_{\text {out }}=2 \mathrm{~V} \text { step } \end{aligned}$ |  | $\begin{aligned} & 57 \\ & 12 \\ & 3 \\ & 50 \\ & 90 \\ & \hline \end{aligned}$ |  | MHz <br> MHz <br> MHz <br> V/ $\mu \mathrm{s}$ <br> ns |
| NOISE/DISTORTION PERFORMANCE <br> Harmonic Distortion SFDR <br> Input Voltage Noise Input Current Noise | $\begin{aligned} & f=500 \mathrm{kHz}, V_{\text {out }}=2 \mathrm{Vp}-\mathrm{p} \\ & \mathrm{f}=1 \mathrm{MHz}, V_{\text {out }}=2 \mathrm{Vp}-\mathrm{p} \\ & \mathrm{f}=100 \mathrm{kHz} \\ & \mathrm{f}=100 \mathrm{kHz} \end{aligned}$ |  | $\begin{aligned} & -95 \\ & -78 \\ & 0.9 \\ & 2.4 \end{aligned}$ |  | dBc dBc $\mathrm{nV} / \sqrt{ } \mathrm{Hz}$ $\mathrm{pA} / \sqrt{ } \mathrm{Hz}$ |
| DC PERFORMANCE Input Offset Voltage Input Offset Voltage Drift Input Bias Current Input Bias Offset Current Input Bias Current Drift Open-Loop Gain | Vout $= \pm 1 \mathrm{~V}$ | 90 | $\begin{aligned} & 30 \\ & 1 \\ & -0.1 \\ & 0.01 \\ & 2 \\ & 94 \\ & \hline \end{aligned}$ | $\begin{aligned} & 150 \\ & \\ & -0.4 \\ & 0.3 \end{aligned}$ | $\mu \mathrm{V}$ $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ $\mu \mathrm{A}$ $\mu \mathrm{A}$ $n A /{ }^{\circ} \mathrm{C}$ dB |
| INPUT CHARACTERISTICS <br> Input Resistance <br> Input Capacitance <br> Input Common-Mode Voltage Range Common-Mode Rejection Ratio | Differential mode Common mode Differential mode Common mode $V_{C M}= \pm 1 \mathrm{~V}$ | $-102$ | $\begin{aligned} & 5 \\ & 30 \\ & 0.8 \\ & 2.2 \\ & -3 \text { to }+2.5 \\ & -120 \end{aligned}$ |  | k $\Omega$ <br> $\mathrm{M} \Omega$ <br> pF <br> pF <br> V <br> dB |
| $\overline{\overline{P D}}$ (Power Down) PIN $\overline{\text { PD Input Voltages }}$ Input Leakage Current | Chip powered down <br> Chip enabled $\begin{aligned} & \overline{\mathrm{PD}}=+\mathrm{V}_{\mathrm{s}} \\ & \overline{\mathrm{PD}}=-\mathrm{V}_{\mathrm{s}} \end{aligned}$ |  | $\begin{aligned} & \leq-4 \\ & \geq-3 \\ & 0.1 \\ & -2 \end{aligned}$ |  | $\begin{aligned} & V \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mu \mathrm{~A} \end{aligned}$ |
| OUTPUT CHARACTERISTICS Output Voltage Swing <br> Short-Circuit Current Off Isolation | $\begin{aligned} & R_{L}=1 \mathrm{k} \Omega \\ & R_{L}=\text { None } \end{aligned}$ <br> Sinking/sourcing $\mathrm{f}=1 \mathrm{MHz}, \overline{\mathrm{PD}}=-\mathrm{V}_{\mathrm{s}}$ | $\begin{aligned} & \pm 3.12 \\ & \pm 3.3 \end{aligned}$ | $\begin{aligned} & \pm 3.17 \\ & \pm 3.34 \\ & 150 \\ & 80 \end{aligned}$ |  | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \end{aligned}$ |
| POWER SUPPLY <br> Operating Range <br> Quiescent Current <br> Positive Power Supply Rejection Ratio Negative Power Supply Rejection Ratio | $\begin{aligned} & \overline{\mathrm{PD}}=+\mathrm{V}_{\mathrm{s}} \\ & \overline{\mathrm{PD}}=-\mathrm{V}_{\mathrm{s}} \\ & +\mathrm{V}_{\mathrm{S}}=5 \mathrm{~V} \text { to } 7 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V} \\ & +\mathrm{V}_{\mathrm{s}}=5 \mathrm{~V},-\mathrm{V}_{\mathrm{s}}=-5 \mathrm{~V} \text { to }-7 \mathrm{~V} \end{aligned}$ | $\begin{aligned} & \pm 4.5 \\ & \\ & -95 \\ & -97 \end{aligned}$ | 7.7 <br> 0.1 <br> -100 <br> -104 | $\pm 16.5$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~mA} \\ & \mathrm{~mA} \\ & \mathrm{~dB} \\ & \mathrm{~dB} \end{aligned}$ |

## ADA4898-1

## ABSOLUTE MAXIMUM RATINGS

Table 3.

| Parameter | Rating |
| :--- | :--- |
| Supply Voltage | 36 V |
| Power Dissipation | See Figure 3 |
| Differential Mode Input Voltage | $\pm 1.5 \mathrm{~V}$ |
| Common-Mode Input Voltage | $\pm 11.4 \mathrm{~V}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Operating Temperature Range | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ |
| Lead Temperature (Soldering, 10 sec ) | $300^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL RESISTANCE

$\theta_{J A}$ is specified for the worst-case conditions, that is, $\theta_{\text {IA }}$ is specified for a device soldered in the circuit board with its exposed paddle soldered to a pad on the PCB surface that is thermally connected to a copper plane, with zero airflow.

Table 4.

| Package Type | $\boldsymbol{\theta}_{\mathrm{JA}}$ | $\boldsymbol{\theta}_{\mathrm{Jc}}$ | Unit |
| :--- | :--- | :--- | :--- |
| 8-Lead SOIC with EP on Four-Layer Board | 47 | 29 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## MAXIMUM POWER DISSIPATION

The maximum safe power dissipation in the ADA4898-1 package is limited by the associated rise in junction temperature ( $\mathrm{T}_{\mathrm{J}}$ ) on the die. At approximately $150^{\circ} \mathrm{C}$, which is the glass transition temperature, the plastic changes its properties. Even temporarily exceeding this temperature limit can change the stresses that the package exerts on the die, permanently shifting the parametric performance of the ADA4898-1. Exceeding a junction temperature of $150^{\circ} \mathrm{C}$ for an extended period can result in changes in the silicon devices, potentially causing failure.

The power dissipated in the package $\left(\mathrm{P}_{\mathrm{D}}\right)$ is the sum of the quiescent power dissipation and the power dissipated in the package due to the output load drive. The quiescent power is the voltage between the supply pins ( $\mathrm{V}_{\mathrm{s}}$ ) times the quiescent current ( Is ). The power dissipated due to the load drive depends upon the particular application. For each output, the power due to load drive is calculated by multiplying the load current by the associated voltage drop across the device. RMS voltages and currents must be used in these calculations.

Airflow increases heat dissipation, effectively reducing $\theta_{\mathrm{JA}}$. In addition, more metal directly in contact with the package leads from metal traces, through holes, ground, and power planes reduces the $\theta_{\mathrm{J} A}$. The exposed paddle on the underside of the package must be soldered to a pad on the PCB surface that is thermally connected to a copper plane to achieve the specified $\theta_{J A}$.

Figure 3 shows the maximum safe power dissipation in the package vs. the ambient temperature for the 8 -lead SOIC_EP $\left(47^{\circ} \mathrm{C} / \mathrm{W}\right)$ on a JEDEC standard four-layer board, with its underside paddle soldered to a pad that is thermally connected to a PCB plane. $\theta_{\mathrm{JA}}$ values are approximations.


Figure 3. Maximum Power Dissipation vs. Ambient Temperature

## ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 5. Pin Function Descriptions

| Pin No. | Mnemonic | Description |
| :--- | :--- | :--- |
| 1 | NC | No Connect |
| 2 | - IN | Inverting Input |
| 3 | + IN | Noninverting Input |
| 4 | $-\mathrm{V}_{\mathrm{s}}$ | Negative Supply |
| 5 | NC | No Connect |
| 6 | OUT | Output |
| 7 | $\frac{+V_{s}}{}$ | Positive Supply |
| 8 | PD | Power Down |

## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 5. Small Signal Frequency Response for Various Gains


Figure 6. Small Signal Frequency Response for Various Loads


Figure 7. Small Signal Frequency Response for Various Temperatures


Figure 8. Large Signal Frequency Response for Various Gains


Figure 9. Large Signal Frequency Response for Various Loads


Figure 10. Large Signal Frequency Response for Various Temperatures

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Figure 11. Small Signal Frequency Response for Various Supply Voltages


Figure 12. Small Signal Frequency Response for Various Capacitive Loads


Figure 13. Voltage Noise vs. Frequency


Figure 14. Large Signal Frequency Response for Various Supply Voltages


Figure 15. 0.1 dB Flatness for Various Output Voltages


Figure 16. Input Current Noise vs. Frequency


Figure 17. Open-Loop Gain and Phase vs. Frequency


Figure 18. Harmonic Distortion vs. Frequency and Gain


Figure 19. Harmonic Distortion vs. Frequency and Loads


Figure 20. Harmonic Distortion vs. Output Amplitude


Figure 21. Harmonic Distortion vs. Frequency and Loads


Figure 22. Small Signal Transient Response for Various Capacitive Loads

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Figure 23. Small Signal Transient Response for Various Gains


Figure 24. Large Signal Transient Response for
Various Supply Voltages, $R_{L}=100 \Omega$


Figure 25. Settling Time


Figure 26. Large Signal Transient Response for Various Supply Voltages, $R_{L}=1 \mathrm{k} \Omega$


Figure 27. Large Signal Transient Response for Various Gains


Figure 28. Output Impedance vs. Frequency


Figure 29. Common-Mode Rejection Ratio (CMRR) vs. Frequency


Figure 30. Input Bias Current Distribution


Figure 31. Input Offset Voltage Distribution, $V_{s}= \pm 15 \mathrm{~V}$


Figure 32. Power Supply Rejection Ratio (PSRR) vs. Frequency


Figure $33 . \overline{P D}$ Isolation vs. Frequency


Figure 34. Input Offset Voltage Distribution, $V_{s}= \pm 5 \mathrm{~V}$

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## TEST CIRCUITS



Figure 35. Typical Noninverting Load Configuration


Figure 36. Positive Power Supply Rejection

Figure 37. Common-Mode Rejection



Figure 38. Typical Capacitive Load Configuration


Figure 39. Negative Power Supply Rejection

## THEORY OF OPERATION

The ADA4898-1 is a voltage feedback op amp that combines unity-gain stability with $0.9 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$ input noise. It employs a highly linear input stage that can maintain greater than -90 dBc (@ 2 V p-p) distortion out to 500 kHz while in a unity-gain configuration. This rare combination of low gain stability, low input referred noise, and extremely low distortion is the result of Analog Devices, Inc., proprietary op amp architecture and high speed complementary bipolar processing technology.

The simplified ADA4898-1 topology, shown in Figure 40, is a single gain stage with a unity-gain output buffer. It has over 100 dB of open-loop gain and maintains precision specifications such as CMRR, PSRR and offset to levels that are normally associated with topologies having two or more gain stages.


## $\overline{\mathbf{P D}}$ (POWER DOWN) PIN

The $\overline{\mathrm{PD}}$ pin saves power by decreasing the quiescent power dissipated in the device. It is very useful when power is an issue and the device does not need to be turned on at all times. The response of the device is rapid when going from a power down mode to full power operation mode. Note that $\overline{\mathrm{PD}}$ does not put the output in a high- Z state, which means that the ADA4898-1 is not recommended for use as a multiplexer.

## CURRENT NOISE MEASUREMENT

To measure the very low ( $2.4 \mathrm{pA} / \sqrt{ } \mathrm{Hz}$ ) input current noise of the ADA4898-1, $10 \mathrm{k} \Omega$ resistors were used on both inputs of the amplifier. Figure 41 shows the noise measurement circuit used. The $10 \mathrm{k} \Omega$ resistors are used on both inputs to balance the input impedance and cancel the common-mode noise. In addition, a high gain configuration is used to increase the total output noise and bring it above the noise floor of the instrument.


Figure 41. Current Noise Measurement Circuit
The current noise density $\left(\mathrm{I}_{\mathrm{n}}\right)$ is calculated using the following formula:

$$
I_{n}=\frac{\left[e_{n o}{ }^{2}-(11 \times 18.4 \mathrm{nV} / \sqrt{\mathrm{Hz}})^{2}\right]^{1 / 2} \times \sqrt{2}}{20 \mathrm{k} \Omega \times 11}
$$

## ADA4898-1

## APPLICATIONS INFORMATION

## higher feedback gain operation

The ADA4898-1 schematic for the noninverting gain configuration is nearly a textbook example (see Figure 42). The only exception is the feedback capacitor in parallel with the feedback resistor, $\mathrm{R}_{\mathrm{F}}$, but this capacitor is recommended only when using a large $\mathrm{R}_{\mathrm{F}}$ value ( $>300 \Omega$ ). Figure 43 shows the difference between using a $100 \Omega$ resistor and a $1 \mathrm{k} \Omega$ resistor. Due to the high input capacitance in the ADA4898-1 when using a higher feedback resistor, more peaking appears in the closed-loop gain. Using the lower feedback resistor resolves this issue; however, when running at higher supplies ( $\pm 15 \mathrm{~V}$ ) with $100 \Omega \mathrm{R}_{\mathrm{F}}$, the system draws a lot of extra current into the feedback network. To avoid this problem, a higher feedback resistor can be used with a feedback capacitor in parallel. Figure 43 shows the effect of placing a feedback capacitor in parallel with a larger $\mathrm{R}_{\mathrm{F}}$. In this gain of 2 configuration, $\mathrm{R}_{\mathrm{F}}=\mathrm{R}_{\mathrm{G}}=1 \mathrm{k} \Omega$ and $C_{F}=2.7 \mathrm{pF}$. When using $\mathrm{C}_{\mathrm{F}}$, the peaking drops from 6 dB to less then 2 dB .


Figure 42. Noninverting Gain Schematic


Figure 43. Small Signal Frequency Response for Various Feedback Impedances

## RECOMMENDED VALUES FOR VARIOUS GAINS

Table 6 provides a useful reference for determining various gains and associated performance. Resistor $\mathrm{R}_{\mathrm{F}}$ is set to $100 \Omega$ for gains greater than 1 . A low feedback $\mathrm{R}_{\mathrm{F}}$ resistor value reduces peaking and minimizes the contribution to the overall noise performance of the amplifier.

Table 6. Various Gains and Recommended Resistor Values Associated (Conditions: $\mathrm{V}_{\mathrm{S}}= \pm 5 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega, \mathrm{R}_{\mathrm{T}}=49.9 \Omega$ )

| Gain | RF( $\mathbf{\Omega}$ ) | RG( $\mathbf{\Omega}$ ) | -3 dB SS BW (MHz), <br> $V_{\text {out }}=\mathbf{1 0 0} \mathbf{~ m V ~ p - p}$ | Slew Rate ( $\mathrm{V} / \mu \mathrm{s}$ ), Vout $=2$ V Step | ADA4898-1 Voltage Noise (nV/VHz), RTO | Total System Noise (nV/VHz), RTO |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| +1 | 0 | NA | 65 | 55 | 0.9 | 1.29 |
| +2 | 100 | 100 | 30 | 50 | 1.8 | 3.16 |
| +5 | 100 | 24.9 | 9 | 45 | 4.5 | 7.07 |

## NOISE

To analyze the noise performance of an amplifier circuit, identify the noise sources, and then determine if each source has a significant contribution to the overall noise performance of the amplifier. To simplify the noise calculations, noise spectral densities were used rather than actual voltages to leave bandwidth out of the expressions (noise spectral density, which is generally expressed in $n V / \sqrt{H z}$, is equivalent to the noise in a 1 Hz bandwidth).

The noise model shown in Figure 44 has six individual noise sources: the Johnson noise of the three resistors, the op amp voltage noise, and the current noise in each input of the amplifier. Each noise source has its own contribution to the noise at the output. Noise is generally specified referred to input (RTI), but it is often simpler to calculate the noise referred to the output (RTO) and then divide by the noise gain to obtain the RTI noise.


Figure 44. Op Amp Noise Analysis Model
All resistors have a Johnson noise that is calculated by
$\sqrt{(4 k B T R)}$.
where:
$k$ is Boltzmann's Constant $\left(1.38 \times 10^{-23} \mathrm{~J} / \mathrm{K}\right)$.
$B$ is the bandwidth in Hertz.
$T$ is the absolute temperature in Kelvin.
$R$ is the resistance in ohms.
A simple relationship that is easy to remember is that a $50 \Omega$ resistor generates a Johnson noise of $1 \mathrm{nV} / \sqrt{ } \mathrm{Hz}$ at $25^{\circ} \mathrm{C}$.

In applications where noise sensitivity is critical, care must be taken not to introduce other significant noise sources to the amplifier. Each resistor is a noise source. Attention to the following areas is critical to maintain low noise performance: design, layout, and component selection. A summary of noise performance for the amplifier and associated resistors can be seen in Table 6.

## CIRCUIT CONSIDERATIONS

Careful and deliberate attention to detail when laying out the ADA4898-1 board yields optimal performance. Power supply bypassing, parasitic capacitance, and component selection all contribute to the overall performance of the amplifier.

## PCB LAYOUT

Because the ADA4898-1 can operate up to 65 MHz , it is essential that RF board layout techniques be employed. All ground and power planes under the pins of the ADA4898-1 should be cleared of copper to prevent the formation of parasitic capacitance between the input pins to ground and the output pins to ground. A single mounting pad on a SOIC footprint can add as much as 0.2 pF of capacitance to ground if the ground plane is not cleared from under the mounting pads.

## POWER SUPPLY BYPASSING

Power supply bypassing for the ADA4898-1 has been optimized for frequency response and distortion performance. Figure 42 shows the recommended values and location of the bypass capacitors. Power supply bypassing is critical for stability, frequency response, distortion, and PSR performance. The $0.1 \mu \mathrm{~F}$ capacitors shown in Figure 42 should be as close to the supply pins of the ADA4898-1 as possible. The $10 \mu \mathrm{~F}$ electrolytic capacitors should be adjacent to but not necessary close to the $0.1 \mu \mathrm{~F}$ capacitors. The capacitor between the two supplies helps improve PSR and distortion performance. In some cases, additional paralleled capacitors can help improve frequency and transient response.

## GROUNDING

Ground and power planes should be used where possible. Ground and power planes reduce the resistance and inductance of the power planes and ground returns. The returns for the input and output terminations, bypass capacitors, and $\mathrm{R}_{\mathrm{G}}$ should all be kept as close to the ADA4898-1 as possible. The output load ground and the bypass capacitor grounds should be returned to the same point on the ground plane to minimize parasitic trace inductance, ringing, and overshoot and to improve distortion performance.

The ADA4898-1 package features an exposed paddle. For optimum electrical and thermal performance, solder this paddle to ground. For more information on high speed circuit design, see A Practical Guide to High-Speed Printed-Circuit-Board Layout at www.analog.com.

## ADA4898-1

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AA
CONTROLLING DIMENSIONS ARE IN MILLIMETER; INCH DIMENSIONS
(IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR
REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.


Figure 45. 8-Lead Standard Small Outline Package with Exposed Pad [SOIC_N_EP] (RD-8-1)
Dimensions shown in millimeters and (inches)

ORDERING GUIDE

| Model | Temperature Range | Package Description | Package Option | Ordering Quantity |
| :--- | :--- | :--- | :--- | :--- |
| ADA4898-1YRDZ $^{1}$ | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | 8-Lead SOIC_N_EP | RD-8-1 | 1 |
| ADA4898-1YRDZ-R7 $^{1}$ | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | 8-Lead SOIC_N_EP | RD-8-1 | 1,000 |
| ADA4898-1YRDZ-RL $^{1}$ | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ | 8-Lead SOIC_N_EP | RD-8-1 | 2,500 |

${ }^{1} Z=$ RoHS Compliant Part.

